

METHOD FOR TRANSFERRING A SEALING LAYER**ABSTRACT**

- 5 The invention relates to a method for transferring a layer onto a carrier substrate, the method comprising:
- a) a step of forming cavities in a carrier substrate, said cavities opening in a main face,
 - b) a step of transferring a sealing layer to seal all of the cavities formed during step a),
- 10 step a) being executed such that all of the cavities are distributed regularly over a main zone of the main face, and such that said main face comprises a peripheral ring with no cavities and inside which the main zone is circumscribed, the peripheral ring extending from the edge of the carrier substrate over a length L less than a predetermined length L_p below which the sealing layer is free of non-transferred zones in the peripheral ring.

15 **Figure 16**